

FQP27N25 250V N-Channel MOSFET

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply.

Features

- + 25.5A, 250V, $R_{DS(on)}$ = 0.11 Ω @V_{GS} = 10 V + Low gate charge (typical 50 nC)
- Low Crss (typical 45 pF)
- Fast switching
- · 100% avalanche tested
- · Improved dv/dt capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQP27N25	Units
V _{DSS}	Drain-Source Voltage		250	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		25.5	A
	- Continuous (T _C = 100°C)		16.2	А
I _{DM}	Drain Current - Pulsed	(Note 1)	102	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	600	mJ
I _{AR}	Avalanche Current	(Note 1)	25.5	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	18	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
PD	Power Dissipation (T _C = 25°C)		180	W
	- Derate above 25°C		1.43	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case		0.7	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5		°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

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ТМ

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	250			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C		0.29		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 250 V, V _{GS} = 0 V			1	μA
		V _{DS} = 200 V, T _C = 125°C			10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	ractoristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 12.75 A		0.083	0.11	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 12.75 A (Note 4)		24		S
Dynam C _{iss}	IC Characteristics Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		1900	2450	pF
		$V_{DS} = 25 V, V_{GS} = 0 V,$		360	470	nF
Cres	Reverse Transfer Capacitance	1 - 1.0 WHZ		45	60	pF
Switchi	ng Characteristics	I			75	
^L d(on)	Turn-On Delay Time	V _{DD} = 125 V, I _D = 27 A,		32	75	ns
հ	Turn-On Rise Time	R _G = 25 Ω		270	550	ns
^t d(off)	Turn-Off Eall Time	(Note 4, 5)		00 120	250	ns
<u>ч</u>				120	250	ns
		$V_{\rm DS} = 200 \text{ V}, \text{ I}_{\rm D} = 27 \text{ A},$		12.5	05	10
	Cate Drain Charge	$V_{GS} = 10 V$ (Note 4.5)		12.0		10
⊲gd	Gate-Drain Charge			20		nc
Drain-S	ource Diode Characteristics a	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				25.5	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	Forward Current			102	Α
					4 5	

 V_{GS} = 0 V, I_{S} = 27 A,

 dI_F / dt = 100 A/µs

(Note 4)

220

1.8

ns

μC

Q _{rr}	
Notes	

t_{rr}

Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 1.5mH, $I_{AS} = 25.5A$, $V_{DD} = 50V$, $R_G = 25 \Omega$, Starting $T_J = 25^{\circ}C$ 3. $I_{SD} \le 27A$, di/dt $\le 300A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$ 4. Pulse Test : Pulse width $\le 300\mu s$, Duty cycle $\le 2\%$ 5. Essentially independent of operating temperature

Reverse Recovery Time

Reverse Recovery Charge

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